

Key performance:

- $V_{CE}=750V$
- $I_C=820A@T_C=100^{\circ}C$
- $V_{CE(sat)}=1.6V$

Features:

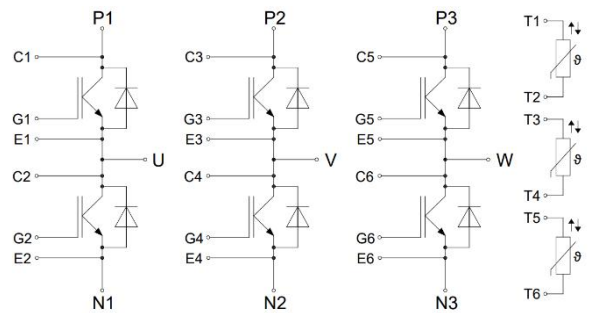
- Low V_{CEsat} .
- Low switching losses.
- Low stray inductance design.
- Positive V_{CEsat} temperature coefficient.


Benefits:

- High efficiency for application.
- Integrated NTC temperature sensor.
- RoHS compliant.

Applications:

- Motor drives
- Automotive applications



Maximum rated values , IGBT

Parameter	Conditions	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	750	V
Implemented collector current		I_{CN}	820	A
Continuous DC collector current	$T_F=80^{\circ}\text{C}$, $T_{vj\max} = 175^{\circ}\text{C}$	$I_{C,nom}$	450	A
Repetitive peak collector current	$t_p = 1\text{ ms}$	I_{CRM}	1500	A
Gate-emitter peak voltage		V_{GES}	± 20	V

Characteristic values , IGBT

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 820\text{A}$, $V_{GE} = 15\text{ V}$ $T_{vj} = 25^{\circ}\text{C}$	V_{CESat}	-	1.6	-	V
Gate threshold voltage	$I_C = 1\text{ mA}$, $V_{CE} = V_{GE}$ $T_{vj} = 25^{\circ}\text{C}$	V_{Geth}	-	5.1	-	V
Collector-emitter cut-off current	$V_{CE} = 750\text{ V}$, $V_{GE} = 0\text{ V}$, $T_{vj} = 25^{\circ}\text{C}$	I_{CES}	-	-	1.0	mA
Gate-emitter leakage current	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$, $T_{vj} = 25^{\circ}\text{C}$	I_{GES}	-	-	500	nA
Input capacitance	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=100\text{kHz}$	C_{ies}	-	31	-	nF
Reverse transfer capacitance		C_{res}	-	0.26	-	nF
Gate charge	$V_{GE}=\pm 15\text{V}$	Q_G	-	4.6	-	μC
Short circuit current	$V_{CC}=400\text{V}$, $V_{GE} \leq 15\text{V}$, $t_p \leq 6\mu\text{s}$, $T_{vj}=150^{\circ}\text{C}$	I_{SC}	-	3800	-	A
Turn-on delay time, inductive load	$I_C = 450\text{A}$, $V_{CE} = 400\text{ V}$ $V_{GE} = \pm 15\text{ V}$ $R_G = 5.1\Omega$ $T_{vj} = 25^{\circ}\text{C}$	$t_{d(on)}$	-	0.31	-	μs
Rise time, inductive load		t_r	-	0.77	-	μs
Turn-off delay time, inductive load		$t_{d(off)}$	-	1.0	-	μs
Fall time, inductive load		t_f	-	0.05	-	μs
Turn-on energy loss per pulse		E_{on}	-	14.8	-	mJ
Turn-off energy loss per pulse		E_{off}	-	25.9	-	mJ

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Module inductance		L_M	-	8	-	nH
Temperature under switching conditions		$T_{vj\ op}$	-40	-	150	°C

Maximum rated values , Diode

Parameter	Conditions	Symbol	Values	Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ\text{C}$	V_{RRM}	750	V
Implemented forward current		I_{FN}	820	A
Continuous DC forward current		I_F	450	A
Repetitive peak forward current	$t_p = 1\ \text{ms}$	I_{FRM}	1500	A
I^2t - value	$V_R=0\text{V}, t_p=10\text{ms}, T_{vj}=150^\circ\text{C}$	I^2t	14.4	kA^2S

Characteristic values , Diode

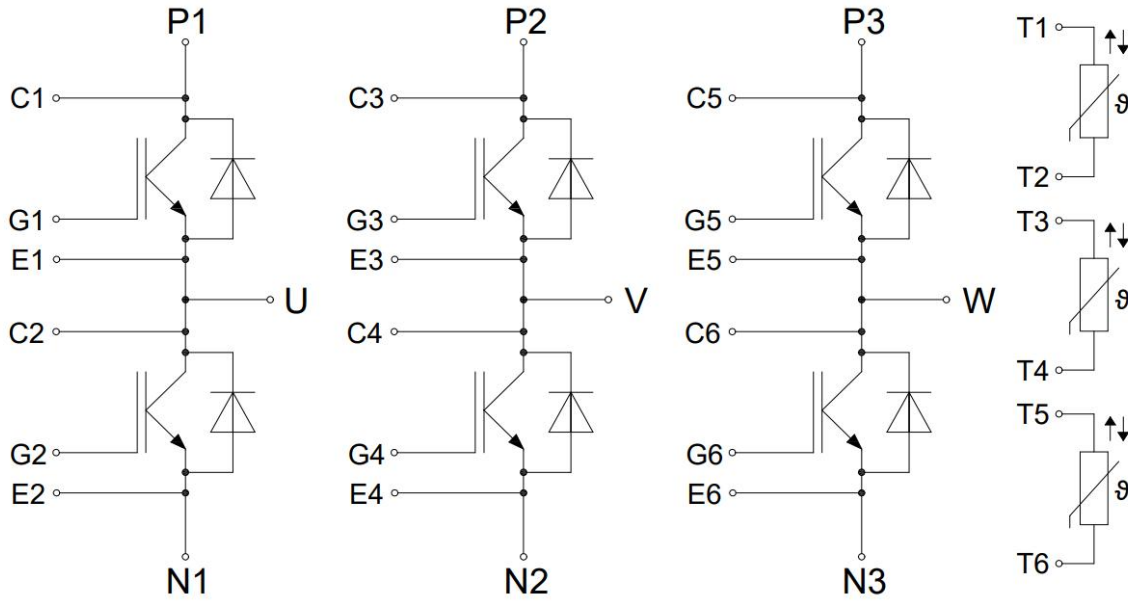
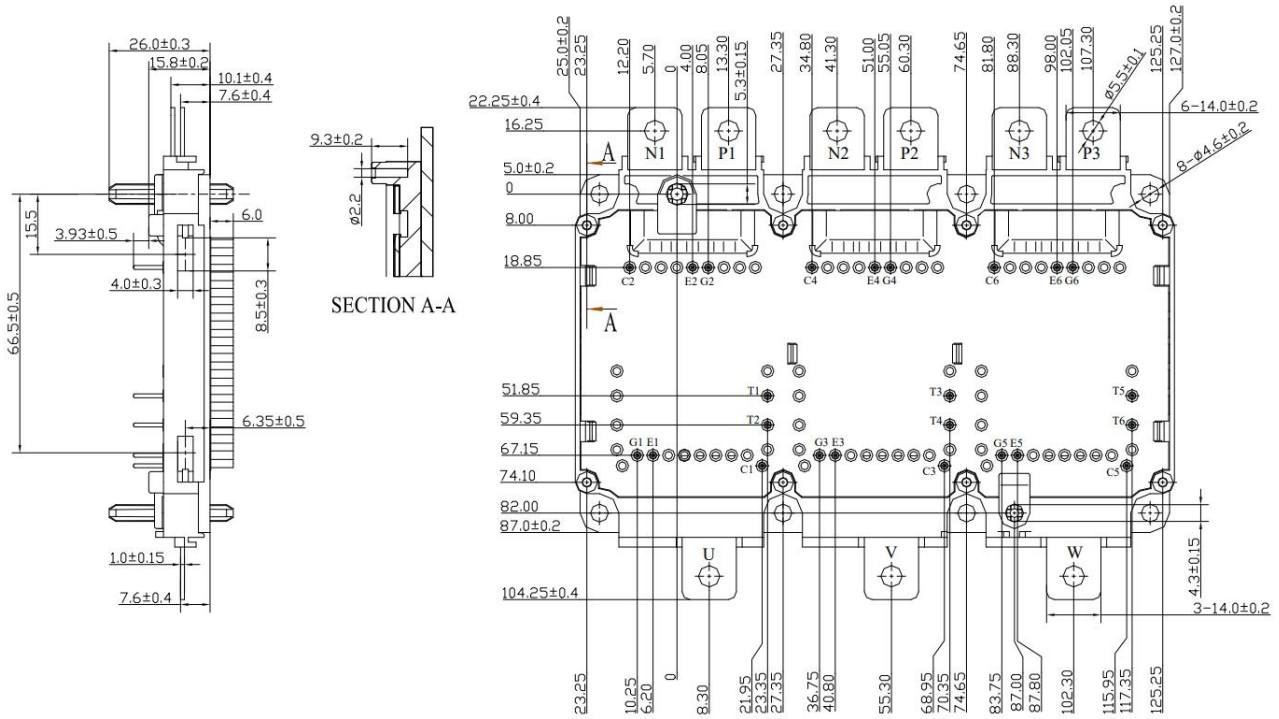
Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F = 450\text{A}, V_{GE} = 0\ \text{V}$ $T_{vj} = 25^\circ\text{C}$	V_F	-	1.7	-	V
Peak reverse recovery current	$I_F=450\text{A}, V_R=400\text{V},$ $-di_F/dt=2300\ \text{A/us}$	I_{RM}	-	51	-	A
Recovered charge		Q_{rr}	-	6.1	-	μC
Reverse recovery energy		E_{rec}	-	1.7	-	mJ
Temperature under switching conditions		$T_{vj\ op}$	-40	-	150	°C

NTC - thermistor

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$T_C=25^\circ\text{C}$	R_{25}	-	5	-	k Ω
Deviation of R100	$T_C=100^\circ\text{C}$, $R_{100}=493\Omega$	$\Delta R/R$	-5	-	5	%
Power dissipation	$T_C=25^\circ\text{C}$	P_{25}	-	-	20.0	mW
B-value	$R_2=R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{K}))]$	$B_{25/50}$	-	3375	-	K
B-value	$R_2=R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{K}))]$	$B_{25/50}$	-	3411	-	K
B-value	$R_2=R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{K}))]$	$B_{25/50}$	-	3433	-	K

Module

Parameter	Conditions	Symbol	Values	Unit
Isolation test voltage	AC RMS, 1 min, 50Hz, $T_C=25^\circ\text{C}$	V_{ISOL}	2.5	kV
Material of module baseplate			Cu	
Material of internal isolation			Si3N4	
Creepage distance	Thermal to heatsink		9.0	mm
	Thermal to terminal		9.0	mm
Clearance	Terminal to heatsink		4.5	mm
	Terminal to terminal		4.5	mm
Storage temperature		T_{stg}	-40 ~ +125	$^\circ\text{C}$
Mounting torque for module mounting	Mounting – M4	M	1.8 ~ 2.2	Nm
Weight		G	730	g

Circuit diagram

Package outlines (mm)


Revision history

Date	Revision	Changes
Jan 11, 2025	Rev 1.0	Release of the preliminary datasheet.

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